

PEROVSKITES

Unlocking Interfaces in Photovoltaics

Eliminating defects at interfaces enables perovskites to approach efficiency limits.

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Demand for energy in the context of climate change are driving rapid deployment of low-cost renewable energy and are accelerating efforts to deliver advanced photovoltaic (PV) technologies. In the past decade, the steeply rising solar-to-electrical power conversion efficiency of metal-halide perovskite solar cells (PSCs) make them a compelling candidate for next-generation PV, with interesting applications envisaged beyond traditional solar plants. These include building integrated PV, flexible solar-powered electronics, solar vehicles, and aircrafts. Metal-halide perovskites benefit from the low formation energy for crystallization, a consequence of their ionic nature, which enables close to ambient-temperature solution or vapor-phase deposition and a thin-film crystallization process. However, the ease by which rapid crystallization occur also introduces defects and local heterogeneities throughout the perovskite films, and at internal interfaces (1).

PSCs can deliver higher efficiencies with fewer fundamental losses than other polycrystalline PV technologies without the need for high-temperature crystallization or dedicated defect control. This phenomenon, often described as ‘defect tolerance’, is ascribed to the specific electronic structure and defect chemistry, where the predominant crystal defects have energy levels close to the conduction and valence bands and thus minimizing the negative effect on charge transport (2). However, despite the relatively benign nature of these defects, their presence has been correlated with long-term degradation, such as acting as mediation sites for ion migration that can initiate material decomposition. In order to reach efficiencies approaching thermodynamic limits, most of the defects in the bulk, grain boundaries, surfaces and interfaces need to be eliminated or well passivated.

A PSC is constructed with a solid perovskite thin-film, sandwiched between electron-

and hole-selective charge transport layers (ETLs, HTLs or CTLs) and metallic contacts beneath and on-top of the CTLs, assembled in a layer-by-layer process (see the figure). The surfaces of the perovskite film, and the heterojunctions formed with the CTLs are the most detrimental regions for losses, which reduce the chemical potential of photogenerated carriers and in turn limit the achievable open-circuit voltage and efficiency. Because the surface represents the discontinuity of bulk perovskite, the unterminated bonds and vacancies become the main defect reservoir for charge trapping and non-radiative recombination. Over the last ten years there have been numerous attempts to realize single-crystal PSCs, with the perception that eliminating the polycrystalline grain boundaries and hence defects at the grain boundaries will lead to improved performance and stability (3). However, even without appropriate passivation, internal recombination losses in polycrystalline perovskite films are usually less important than charge trapping and recombination at the surfaces and heterojunctions. With surface passivation, recombination can just about be eliminated in polycrystalline thin films (4). Specifically, the most stable and efficient p-i-n PSCs use fullerene and its derivatives as the ETL. Recombination at this perovskite/fullerene interface dominates the bulk recombination by 1 to 3 orders of magnitude. The possible origin of the fullerene-induced interfacial recombination could be either the existence of charge transfer states or low-lying states due to the density of state broadening. Conclusively understanding the recombination loss mechanism still requires more exploration.

In addition to the top surfaces, the “buried heterojunction” is equally important while much less accessible. A key property of the buried interface is that the perovskite film is grown and crystallized upon the underlying layers. The underlying surface influences many properties, such as nucleation, crystal growth, and even the electrical “doping”, or Fermi level, of the perovskite film (5). Therefore, comprehensively understanding the formation dynamics of the buried interface is important to effectively eliminate or passivate the buried defects. For solution-processed perovskites, poor wettability and less-controllable crystallization processes are speculated to relate to the local accumulation of small crystallites or amorphous species and lead to the generation

of charge-traps at the interface (6). In addition, detrimental “voids” can form because of the delayed escape of low-volatility solvents entrapped at the buried regions, which jeopardize the film mechanical reliability (7). Macroscopic defects, such as delamination of the perovskite film from the underlying substrate, can be generated during the crystallization due to the inherent soft but brittle nature and high thermal expansion coefficients of perovskites that inevitably induce strain (8).

Perovskites as solar absorber layers are generally formed from a three-dimensional (3D) lattice structure with an “ABX₃” stoichiometry (A, B, and X denote monovalent cation, divalent cation, and anion, respectively). Furthermore, a whole range of “layered” or “two-dimensional (2D)” perovskites exist, incorporating larger A-site cations, which have wider band gaps than their 3D counterparts, but can have similar lattice constants in at least two of the three crystal planes. Forming 2D capping layers atop the bulk perovskite, and hence a 3D/2D heterojunction with lattice matching, is one successful passivation strategy for perovskites, and thin-film PV materials more generally (9). Insertion of an interlayer, such as few nm-thick LiF₂ or MgF₂, is another powerful method, which tends to reduce interfacial recombination, presumably due to the physical separation of perovskite and ETL. At the buried interface in p-i-n PSCs, substantial reduction in recombination losses has been enabled via the use of self-assembled monolayers (SAMs) (10). How or why they work so well is still not clear, but in some instances the losses at the buried interface can be almost eliminated. Non-charge transporting SAMs can also play a role at the buried interface. With the aid of one anchoring group and one functional group, SAMs can easily adhere to and be designed to modulate the subsequently grown perovskite surfaces (8).

Advances in characterization methods have expanded understanding and enabled more insightful analysis. Multimodal microscopy reveals crystal orientation variations and correlates the sub-grain misorientation with local strain, pointing out the structural sources of nonradiative recombination (11). Depth-resolved spectroscopic measurements as well as in-situ and operando techniques emerge as critically important assessment tools for buried interfaces and their impact on device operation. The emerging “lift-off” techniques,

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1 where the perovskite layers are peeled off the
2 substrate, allows the buried interfaces to be
3 exposed, enabling direct microscopic mapping
4 and surface-sensitive probing of the underly-
5 ing surface (12). Notably, similar lift-off meth-
6 odologies have proven effective and useful in
7 other thin-film PV materials, such as CdTe, and
8 insights gained from different materials
9 should lead to more rapid advances in charac-
10 terization methodologies (13).

11 With the substantial progress on interfac-
12 es, a growing consensus is forming about the
13 requirements for an ideal perovskite interface:
14 (i) the elimination or repair of sur-
15 face/interface defects; (ii) the design of a ra-
16 tional energy landscape to satisfy selective
17 carrier collection; (iii) the minimization of
18 strain/stress; and (iv) the improvement of
19 physical robustness and adhesion.

20 Numerous passivation strategies aim to
21 reduce the interfacial defect densities, while
22 the detailed atomistic nature of defects and
23 the electronic influence of differing defect
24 types at the interface remains uncertain.
25 What is easy to overlook is that the “pas-
26 sivat” employed are also foreign species,
27 which may induce complex electronic states
28 at the interfaces.

29 The fabrication of 2D/3D perovskite het-
30 erojunctions need to form a rational energy
31 landscape at the interface for smooth charge
32 transportation of one carrier type and reflec-
33 tion of the other. Most of the large-organic-
34 spacer-involved 2D perovskites present more
35 of a p-type nature than the 3D counterparts.
36 This makes inserting this layer most favorable
37 at the interface of perovskite/p-type CTL, spe-
38 cifically on top of the perovskite layer for n-i-p
39 cells and buried underneath the perovskite for
40 p-i-n cells. If the distribution of multiple quan-
41 tum wells in 2D or quasi-2D layers can be fur-
42 ther controlled, the energy landscape can be
43 tuned to enable high electron selectivity at the
44 top interface (14).

45 Challenges remain for the selection of
46 CTLs, especially when targeting both high effi-
47 ciency and high stability (15). Spiro-bifluorene
48 derivatives, along with a host of ionic additives
49 and p-dopants, seem essential for HTL in high-
50 efficiency n-i-p devices, but suffer from seri-
51 ous ion migration and thermal instabilities.
52 Fullerene derivatives are commonly used as
53 ETLs in p-i-n cells, but show severe recombina-
54 tion losses at the perovskite interfaces and are
55 a weak point for delamination. Substantial
56 improvements of p-i-n device performance
57 and stability are expected with the develop-
58 ment of new “non-fullerene” ETLs. Some ar-
59 chetypical “non-fullerene acceptors” from or-
ganic PV such as “ITIC” and perylene
derivatives do result in operational PSCs.

However, competitive performance with al-
ternative ETLs has not been achieved. Once a
pathway emerges for this improvement, we
expect that rapid combinatorial modifications
to the organic structures will result in pro-
gress towards realizing ideal perovskite/ETL
heterojunctions.

In comparison with the perovskite top in-
terface, deeper understanding the “buried se-
crets” under the perovskite film requires more
powerful characterization techniques. High-
resolution electron microscopic and near-field
techniques could be responsible for clarifying
nanoscale crystallographic, chemical, and elec-
trical information at the buried interfaces.
Visualization of local carrier behavior at the
buried interface will also benefit from dedicat-
ed high-resolution, ultrafast fluorescence
mapping techniques.

Beyond borrowing characterization meth-
odologies, other synergies exist between the
different PV technologies, from crystalline sili-
con to organic PV materials. Many of the ma-
terials used in organic PVs find use in perov-
skites, and CTL configurations can often be
applied in a sandwich structure device with
both perovskite and organic bulk heterojunc-
tion absorber layers. Key challenges in tradi-
tional thin-film PV are centered around enab-
ling improved charge contacts. For silicon PV,
passivated contacts have proven to deliver the
highest efficiencies, with amorphous silicon or
a thin silicon oxide layer being used in silicon
heterojunction and tunneling oxide passivated
contact (TOPCon) cells respectively. However,
a vast range of other heterojunctions have
been explored for silicon. If appropriately ap-
plied, some of the material deposition meth-
odologies and passivation strategies devel-
oped for perovskites may find success when
applied to silicon wafers as well.

The huge progress made in last decade
pushes PSCs forward to be among the most
efficient PV technologies, substantial advances
in operational stability have also been
achieved, positioning perovskites on the brink
of industrialization. Revealing the remaining
mysteries at the interfaces could unlock the
full potential of perovskites.

REFERENCES AND NOTES:

1. E. M. Tennyson *et al.*, *Nat. Rev. Mater.* **4**, 573 (2019)
2. G. Kim *et al.*, *Adv. Energy Mater.* **10**, 2001959 (2020)
3. W. Nie *et al.*, *Science* **347**, 6221 (2015)
4. Y. Shi *et al.*, *ACS Energy Lett.* **7**, 4081 (2022)
5. J. Euvrard *et al.*, *Nat. Rev. Mater.* **6**, 531 (2021)
6. Z. Ni *et al.*, *Science* **367**, 1352 (2020)
7. S. Chen *et al.*, *Science* **373**, 902 (2021)
8. Z. Dai *et al.*, *Science* **372**, 618 (2021)
9. D. McGott *et al.*, *Joule* **5**, 1057 (2021)
10. A. Al-Ashouri *et al.*, *Energy Environ. Sci.* **12**, 3356 (2019)
11. S. Jariwala *et al.*, *Joule* **3**, 3048 (2019)

12. X. Yang *et al.*, *Adv. Mater.* **33**, 2006435 (2021)
13. D. McGott *et al.*, *ACS Appl. Mater. Interfaces* **10**, 44854 (2018)
14. S. Sidhik *et al.*, *Science* **377**, 1425 (2022)
15. P. Schulz *et al.*, *Chem. Rev.* **119**, 3349 (2019)

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Fig. 1 Roadmap for perfecting the interfaces in perovskite solar cells.